5x7mm Surface Mount High Precision TCXO

In Stock at Digi-Key

CONNOR WINFIELD

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Description

The Connor-Winfield's D75F - Series are 5x7mm Surface Mount Temperature Compensated Crystal Controlled Oscillators (TCXO) with a Tri-State LVCMOS output. Through the use of Analog Temperature Compensation, the D75F - Series are capable of holding sub 1-ppm stabilities over the 0 to 70°C temperature range.

Features

Model D75F

TCXO
3.3V Operation
LVCMOS Output Logic
Frequency Stability: ±0.50ppm
Temperature Range: 0 to 70°C
Low Jitter <1pS RMS
Tri-State Enable/Disable Function
5x7mm Surface Mount Package
Tape and Reel Packaging
RoHS Compliant / Lead Free ✓RoHS

Specifications

Absolute Maximum Ratings

Parameter		Minimum	Nominal	Maximum	Units	Note
Storage Temperature		-55	-	85	°C	
Supply Voltage	(Vcc)	-0.5	-	6.0	Vdc	
Input Voltage		-0.5	-	Vcc+0.5	Vdc	

Operating Specifications

Parameter		Minimum	Nominal	Maximum	Units	Note
Frequencies Available	(Fo)		13.0, 19.44, 25.0, 27.0		MHz	
Frequency Calibration @ 25 C		-1.0	-	1.0	ppm	1
Frequency Stability [±(Fmax – Fmin)/2.Fo]		-0.5	-	0.5	ppm	2
Supply Voltage Variation (Vcc ±5%)		-0.2	-	0.2	ppm	
Load Coefficient (±5%)		-0.2	-	0.2	ppm	
Static Temperature Hysteresis		-	-	0.4	ppm	3
Aging		-1.0	-	1.0	ppm/year	
Temperature Range		0	-	70	C	
Supply Voltage	(Vcc)	3.135	3.3	3.465	Vdc	
Supply Current	(Icc)	-	-	6	mA	
Period Jitter		-	3	5	ps rms	
Phase Jitter (BW=12kHz to 20MHz)		-	0.5	1	ps rms	
SSB Phase Noise at 10Hz offset		-	-80		dBc/Hz	
SSB Phase Noise at 100Hz offset		-	-110		dBc/Hz	
SSB Phase Noise at 1KHz offset		-	-135		dBc/Hz	
SSB Phase Noise at 10KHz offset		-	-150		dBc/Hz	
SSB Phase Noise at >100KHz offset		-	-150		dBc/Hz	

Input Characteristics For Enable / Disable Function (Pin 8)

Parameter		Minimum	Nominal	Maximum	Units	Note
Enable Voltage (High) or open circuit	(Vih)	70%Vcc	-	-	Vdc	4
Disable Voltage (Low) Output Tri-stated	(Vil)	-	-	30%Vcc	Vdc	

LVCMOS Output Characteristics

Parameter			Minimum	Nominal	Maximum	Units	Note
LOAD			-	15	-	pF	5
Voltage	(High)	(Voh)	90%Vcc	-	-	Vdc	
	(Low)	(Vol)	-	-	10%Vcc	Vdc	
Current	(High)	(Ioh)	-4	-	-	mA	
	(Low)	(Iol)	-	-	4	mA	
Duty Cycle at 50% of Vcc			45	50	55	%	
Rise / Fall Time 10% to 90%			-	-	8	ns	

Note:

1) Initial calibration @ 25 C. Specifications at time of shipment after 48 hours of operation
2) Frequency stability vs. change in temperature.
3) Frequency change after reciprocal temperature ramped over the operating range. Frequency measured before and after at 25°C.
4) Leave Pad 8 unconnected if enable / disable function is not required. When tri-stated, the output stage is disabled but the oscillator and compensation circuit are still active (current consumption ≤ 1 mA).
5) or best performance it is recommended that the circuit connected to this output should have an equivalent input capacitance of 15pF.

RoHS COMPLIANT

Bulletin	Tx237
Page	1 of 2
Revision	01
Date	14 Nov 2008

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Package Characteristics

Package	Ceramic Surface Mount Package.

Environmental Characteristics

Vibration:	Vibration per Mil Std 883E Method 2007.3 Test Condition A
Shock:	Mechanical Shock per Mil Std 883E Method 2002.4 Test Condition B.
Soldering:	SMD product suitable for Convection Reflow soldering. Peak temperature 260 C. Maximum time above 220 C, 60 seconds.
Solderability	Solderability per Mil Std 883E Method 2003

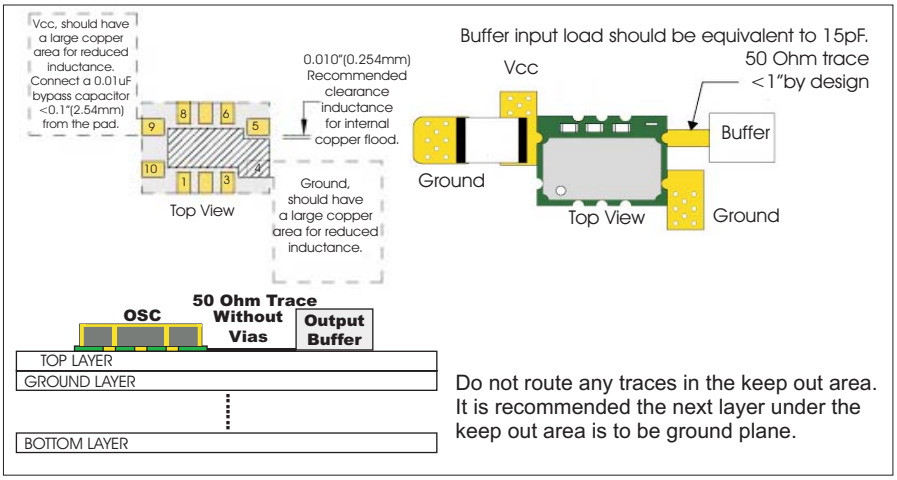
Ordering Information

D75F - 013.0MHZ *
D75F - 019.44MHZ *
D75F - 025.0MHZ *
D75F - 027.0MHZ *

TCXO SERIES — CENTER FREQUENCY

* For the tape and reel option, add -T to the end of the part number.
Example: D75F-027.0 MHZ -T

Design Recommendations

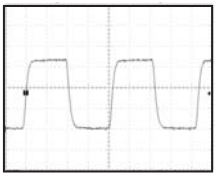


Do not route any traces in the keep out area. It is recommended the next layer under the keep out area is to be ground plane.

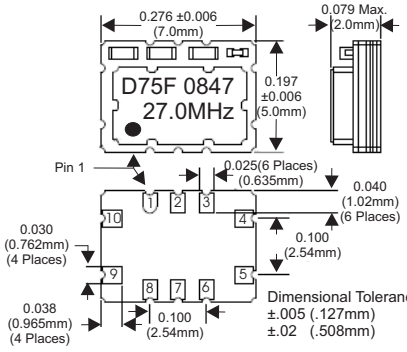
Pad Connections

Pad	Connection
1	Do not connect
2	Do not connect
3	Do not connect
4	Ground
5	Output
6	Do not connect
7	Do not connect
8	Tri-state Enable / Disable
9	Supply, Vcc
10	Do not connect

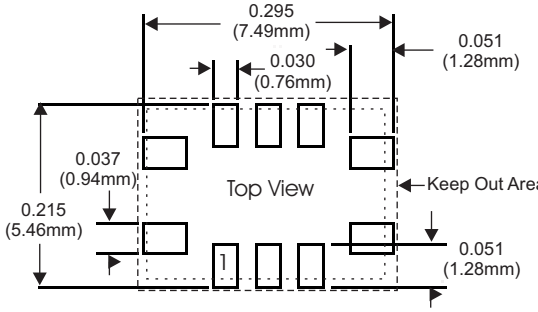
Output Waveform



Package Layout



Suggested Pad Layout



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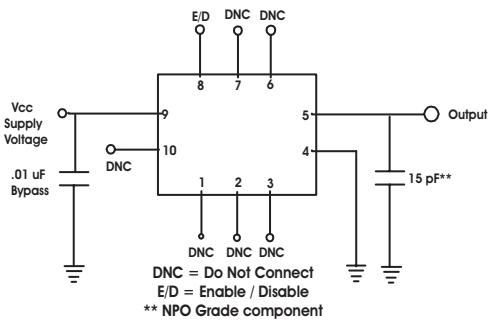
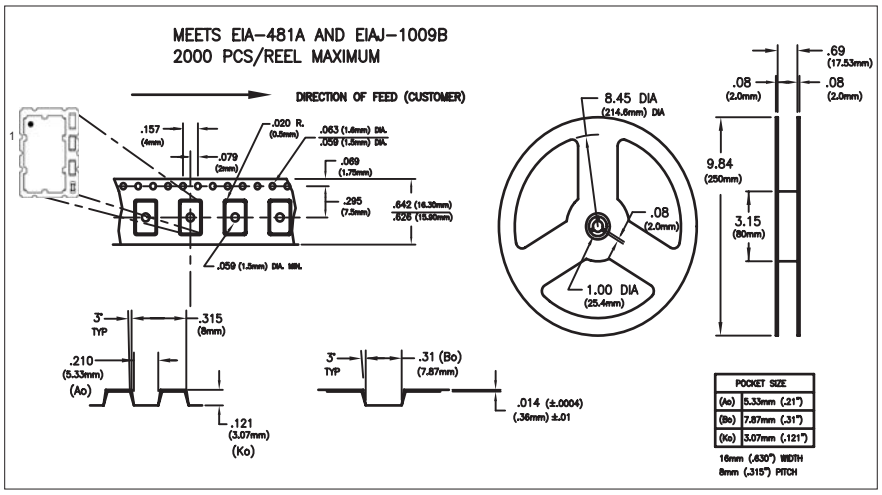
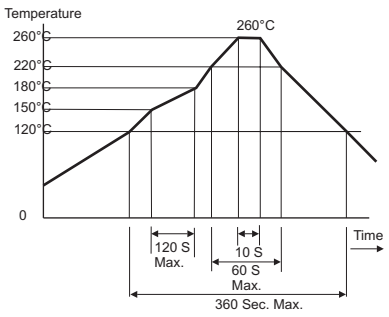
Test Circuit



Tape and Reel Information



Solder Profile



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